



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Marcos Karnezos

Application No.: 10/618,933

Filed: July 14, 2003

**Title: Semiconductor multi-package module including processor and memory package assemblies**

Examiner: Alonzo Chambliss

Group Art Unit: 2827

Date: September 9, 2005

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on September 9, 2005.

**Signed**

**Bill Kennedy**

**MAIL STOP AMENDMENT**  
**COMMISSIONER FOR PATENTS**  
**P.O. Box 1450**  
**Alexandria, VA 22313-1450**

## AMENDMENT

Dear Sir:

In response to the Office action mailed March 9, 2005, kindly amend the application as follows.

Amendments to the claims are reflected in the **Listing of Claims**, which begins on page 2 of this paper.

**Amendments to the Specification** begin on page 10 of this paper.

**Amendments to the Drawings** begin on page 12 of this paper and include both an attached replacement sheet and an annotated sheet showing changes.

**Remarks** begin on page 13 of this paper.

An **Appendix** including amended drawing figures is attached following page 18 of this paper.